

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company	 STMicroelectronics International N.V
1.2 PCI No.	MICROCONTROLLERS/24/14926
1.3 Title of PCI	ASE Kaohsiung Enhanced traceability with 2D marking for LQFP7x7, LQFP10x10, LQFP14x14, LQFP20x20 & LQFP24x24 additional list of products (Addendum to PCI14718)
1.4 Product Category	All listed products
1.5 Issue date	2024-08-18

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Ricardo Antonio DE SA EARP
2.2.2 Marketing Manager	Veronique BARLATIER
2.2.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Methods	Traceability (marking content, company logo, etc)	ASE Kaohsiung (Taiwan)

4. Description of change

	Old	New
4.1 Description	Marking composition with no 2D marking	New marking composition with 2D marking for production assembly
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Form: Change is visible on marking area Fit : No change Function : No change Reliability : No change Processability : No change	

5. Reason / motivation for change

5.1 Motivation	To enhance traceability
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	2D marking visible on top device marking
-----------------	--

7. Timing / schedule

7.1 Date of qualification results	2024-08-06
7.2 Intended start of delivery	2024-09-02
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description	14926 PCI14926 - validation.pdf
8.2 Qualification report and qualification results	Available (see attachment)

Issue Date 2024-08-18

9. Attachments (additional documentations)

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32F100VCT6	
	STM32F100VDT6	
	STM32F100VET6	
	STM32F205RGT6W	
	STM32F205VGT6V	
	STM32F205VGT6W	
	STM32F405RGT6V	
	STM32F405RGT6W	
	STM32F405VGT6V	
	STM32F405VGT6W	
	STM32F405ZGT6V	
	STM32F405ZGT6W	
	STM32G473QET6	
	STM32G474QET3	
	STM32G474QET6	
	STM32G474QET6TR	
	STM32G483QET6	
	STM32G484QET6	

IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics – All rights reserved



PCI 14926
ASE Kaohsiung Enhanced traceability with
2D marking for LQFP7x7, LQFP10x10,
LQFP14x14, LQFP20x20 & LQFP24x24
Additional list of products – addendum to
PCI 14718

Validation of the Traceability

July 2024

2D marking – 2DID Code quality check rule

For 2D quality check method is follow ISO TR29158.



Overall	
ISO/IEC TR 29158	
Decode	A
Cell Contrast	A
Cell Modulation	A
Reflectance Margin	A
Fixed Pattern Damage	A
Axial Nonuniformity	A
Grid Nonuniformity	A
Unused Err. Correction	A
Print Growth Horizontal	A
Print Growth Vertical	A

2D code is auto detect by 2D reader.

Based on 2D quality to determine the grade.
(Follow TR29158 defined item)

- ISO/IEC TR 29158:2011 Information technology - Automatic identification and data capture techniques - Direct Part Mark (DPM) Quality Guideline

2D marking – 2DID Code Vision Pass Rate

2D level	Mark content	2D decode
Overall 		:AA40822204826345

Sch	In Qty	Pass Qty	2DID fail Qty	2DID Pass Rate	2DID fail Rate
08TXP4	1764	1764	0	100%	0%

1. For mark 2DID quality is level A and no abnormal.
2. Confirm the pass rate is 100% to read 2DID.

Marking Inspection

- The yield for 2DID inspection is 100%.

ASET Schedule	2DID inspection result					Owner
441T9K311		Inqty	Pass	Reject	Invalid	Yield
	3409	3409				100%
						PE/AE

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics International NV and its affiliates ("ST") reserve the right to make changes corrections, enhancements, modifications, and improvements to ST products and/or to this document any time without notice.

This document is provided solely for the purpose of obtaining general information relating to an ST product. Accordingly, you hereby agree to make use of this document solely for the purpose of obtaining general information relating to the ST product. You further acknowledge and agree that this document may not be used in or in connection with any legal or administrative proceeding in any court, arbitration, agency, commission or other tribunal or in connection with any action, cause of action, litigation, claim, allegation, demand or dispute of any kind. You further acknowledge and agree that this document shall not be construed as an admission, acknowledgement or evidence of any kind, including, without limitation, as to the liability, fault or responsibility whatsoever of ST or any of its affiliates, or as to the accuracy or validity of the information contained herein, or concerning any alleged product issue, failure, or defect. ST does not promise that this document is accurate or error free and specifically disclaims all warranties, express or implied, as to the accuracy of the information contained herein. Accordingly, you agree that in no event will ST or its affiliates be liable to you for any direct, indirect, consequential, exemplary, incidental, punitive, or other damages, including lost profits, arising from or relating to your reliance upon or use of this document.

Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement, including, without limitation, the warranty provisions thereunder.

In that respect please note that ST products are not designed for use in some specific applications or environments described in above mentioned terms and conditions.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

Information furnished is believed to be accurate and reliable. However, ST assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously in any prior version of this document.

© 2024 STMicroelectronics - All rights reserved



**PRODUCT/PROCESS
CHANGE INFORMATION
PCI14926 – Additional information**

**ASE Kaohsiung Enhanced traceability with 2D marking for
LQFP7x7, LQFP10x10, LQFP14x14, LQFP20x20 & LQFP24x24
additional list of products – Addendum to PCI 14718**

MDRF – General Purpose Microcontrollers sub-group (GPM)

What is the change?

Purpose is to homogenize the marking composition to allow better identification of STM8/STM32 products whatever the production site (for package bigger or equal to 7x7mm body size).

For all listed products marking composition will include 2D information. This enhanced traceability will allow a unique traceability per device from manufacturing to the end customer.

Codes already available on current marking:

PP : Assembly Plant code

LLL : BE sequence

WX : Wafer Diffusion Plant code

SS : ASsembly Sub-Lot

COO : Country Of Origin code

TF : Test & Finishing site code

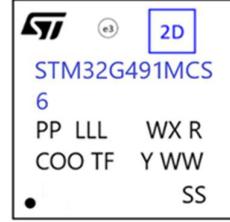
Y WW : Year Week (manufacturing date)

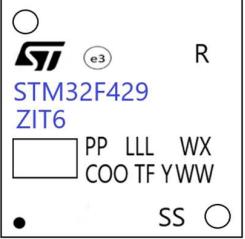
R : **Additional Information** (Die Version)

Impacted Assembly site	COO Country Of Origin	PP Product Plant
ASE KaoHsiung (Taiwan)	TWN	GQ

How can the change be seen?

Table below shows marking examples for different package.

	Current marking composition example	New marking composition example
Impacted Package	Without	With 2D Marking
LQFP 32 7x7x1.4 MM (5V)		
LQFP 48 7x7x1.4 MM (5B)		
LQFP 64 10x10x1.4 MM (5W)		
LQFP 80 14x14x1.4 MM (1S)		
LQFP 100 14x14x1.4 MM (1L)		

Impacted Package	Current marking composition example	New marking composition example
	Without	With 2D Marking
LQFP144 20x20 1.4MM (1A)		
LQFP 176 24x24 1.4MM (1T)		

Some specific highlights:

- New marking will replace current marking.
- To save some space, “TF” code information has been removed from LQFP48 marking.
- Marking area is broken out into two separate lines to allow maximum information to be displayed.
 - o In the new marking condition, the marking area (lines in blue color in above table) will be filled up to the last possible character of the first line and will be resumed on the second line.
- As a consequence, the cardboard box labeling will also display this change, but we may have mismatch between Box Labelling and marking composition of parts inside this box during the transition time for about a few weeks. Refer to below examples of box labeling.

Package size with box labeling examples	Box labeling before:	Box labeling after:
LQFP 32 7x7x1.4 MM	STM8S207 K8T6C V	STM8S20 7K8T6C V
LQFP 48 7x7x1.4 MM	32F100 C8T6B Z	STM32F1 00C8T6B Z
LQFP 64 10x10x1.4 MM	STM32F101 RCT6 2	STM32F101R CT6 2
LQFP 80 14x14x1.4 MM	Z STM32G491 MCS6	STM32G491MCS 6 Z
LQFP 100 14x14x1.4 MM	STM32F071 VBT6 Y	STM32F071VBT 6 Y
LQFP 144 20x20 1.4 MM	32F429ZIT6 4	STM32F429ZIT6 4
LQFP 176 24x24 1.4 MM	STM32F745IGT6 1	STM32F745IGT6 1

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics International NV and its affiliates ("ST") reserve the right to make changes corrections, enhancements, modifications, and improvements to ST products and/or to this document any time without notice. This document is provided solely for the purpose of obtaining general information relating to an ST product. Accordingly, you hereby agree to make use of this document solely for the purpose of obtaining general information relating to the ST product. You further acknowledge and agree that this document may not be used in or in connection with any legal or administrative proceeding in any court, arbitration, agency, commission or other tribunal or in connection with any action, cause of action, litigation, claim, allegation, demand or dispute of any kind. You further acknowledge and agree that this document shall not be construed as an admission, acknowledgement or evidence of any kind, including, without limitation, as to the liability, fault or responsibility whatsoever of ST or any of its affiliates, or as to the accuracy or validity of the information contained herein, or concerning any alleged product issue, failure, or defect. ST does not promise that this document is accurate or error free and specifically disclaims all warranties, express or implied, as to the accuracy of the information contained herein. Accordingly, you agree that in no event will ST or its affiliates be liable to you for any direct, indirect, consequential, exemplary, incidental, punitive, or other damages, including lost profits, arising from or relating to your reliance upon or use of this document.

Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement, including, without limitation, the warranty provisions thereunder.

In that respect please note that ST products are not designed for use in some specific applications or environments described in above mentioned terms and conditions.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

Information furnished is believed to be accurate and reliable. However, ST assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license, express or implied, to any intellectual property right is granted by ST herein. Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously in any prior version of this document.

Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCI Title : ASE Kaohsiung Enhanced traceability with 2D marking for LQFP7x7, LQFP10x10, LQFP14x14, LQFP20x20 & LQFP24x24 additional list of products (Addendum to PCI14718)

PCI Reference : MICROCONTROLLERS/24/14926

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM32G474QCT6	STM32G473QCT6	STM32G474QET6TR
STM32G473QET6TR	STM32G474QBT6	STM32G071CBT7
STM32G473QET6	STM32G473QBT6	STM32G474QET6
STM32G483QET6	STM32G484QET6	STM32F405RGT6V
STM32F205RGT6W	STM32F205ZGT6W	STM32F405ZGT6W
STM32F205RGT6V	STM32F205VGT6V	STM32F405VGT6V
STM32F100VCT6	STM32F405RGT6W	STM32F405ZGT6V
STM32F205ZGT6V	STM32F405VGT6W	STM32F205VGT6W
STM32F100VDT6	STM32F100VET6	

IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2022 STMicroelectronics – All rights reserved